

Customer No.: 31561  
Application No.: 10/710,419  
Docket No.: 11579-US-PA

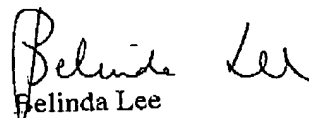
**REMARKS**

In response to the Office Action, mailed on January 31, 2006, a complete listing of all of the claims is presented herewith. Applicant would like to elect Group I, claims 1-13, drawn to semiconductor device, classified in class 257, subclass 737. Please cancel Group II, claims 14-22, drawn to method of making, classified in class 438, subclass 612, without waiver, prejudice or disclaimer.

If the Examiner believes that a telephone conference would expedite the examination of the above-identified patent application, the Examiner is invited to call the undersigned.

Date: February 24, 2006

Respectfully submitted,

  
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